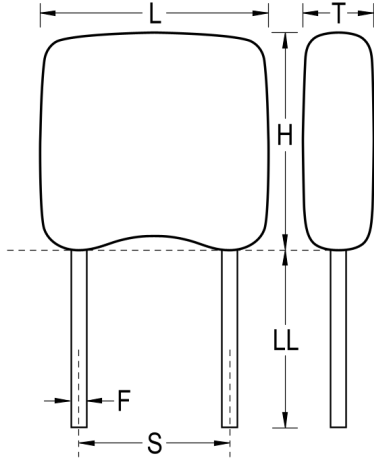


HP08CN104GN

Aliases (HP08CN104G)

HP LDD Indust COG HT200C, Ceramic, 0.1uF, 2%, 100 VDC, COG, Commercial, High Temperature, Lead Spacing = 10.16mm



Dimensions

L	12.7mm MAX
H	12.7mm MAX
T	6.35mm MAX
S	10.16mm +/-0.762mm
LL	3.175mm MIN
F	0.635mm +0.102/-0.051mm

Packaging Specifications

Packaging	Waffle, Tray
Packaging Quantity	1

General Information

Series	HP LDD Indust COG HT200C
Style	Radial
Description	Commercial, High Temperature
Features	LDD High Temperature 200C
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
Termination	Nickel
Failure Rate	N/A
AEC-Q200	No

Specifications

Capacitance	0.1uF
Capacitance Tolerance	2%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Dissipation Factor	0.15%
Insulation Resistance	10 GOhms